

### **Description**

The VSM60P02Y uses advanced trench technology and design to provide excellent  $R_{\text{DS(ON)}}$  with low gate charge .This device is well suited for use as a load switch or in PWM applications.

#### **General Features**

•  $V_{DS} = -60V, I_{D} = -2A$ 

 $R_{DS(ON)}$  <160m $\Omega$  @  $V_{GS}$ =-10V

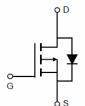
 $R_{DS(ON)}$  <200m $\Omega$  @  $V_{GS}$ =-4.5V

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

#### **Application**

- Load switch
- PWM application





SOT-23-3

Schematic Diagram

## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM60P02Y-S2	VSM60P02Y	SOT-23-3	Ø180mm	8 mm	3000 units

## Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	-60	V	
Gate-Source Voltage	V <sub>G</sub> s	±20	V	
Drain Current-Continuous	I <sub>D</sub>	-2	А	
Pulsed Drain Current (Note 1)	I <sub>DM</sub>	-8	Α	
Maximum Power Dissipation	P <sub>D</sub>	1.7	W	
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 150	$^{\circ}\!\mathbb{C}$	

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup>	$R_{\theta JA}$	73.5	°C/W
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## **Electrical Characteristics (T<sub>C</sub>=25**<sup>°</sup>Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-60	-	-	V	



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Parameter	Symbol	Condition	Min	Тур	Max	Unit
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-60V,V <sub>GS</sub> =0V	-	-	-1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)			•	•		•
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1.4	-2.0	-2.6	V
Desir Course On Otata Basistan	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-2A	-	140	160	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2A	-	160	200	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-2A	-	3	-	S
Dynamic Characteristics (Note4)				•		
Input Capacitance	C <sub>lss</sub>		-	452	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =-30V, $V_{GS}$ =0V, F=1.0MHz	-	27.8	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVIHZ	-	21.5	-	PF
Switching Characteristics (Note 4)			•	•		
Turn-on Delay Time	t <sub>d(on)</sub>		-	40	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-30V, $I_D$ =-2A,	-	35	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10 $V$ , $R_{G}$ =3 $\Omega$	-	15	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	Qg	V - 20 L - 24	-	9.0	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =-30,I <sub>D</sub> =-2A, V <sub>GS</sub> =-10V	-	1.6	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =-10V	-	1.9	-	nC
Drain-Source Diode Characteristics			•	•		•
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-2A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-2	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> =- 2A	-	25		nS
Reverse Recovery Charge	Qrr	$di/dt = -100A/\mu s^{(Note3)}$	-	31		nC

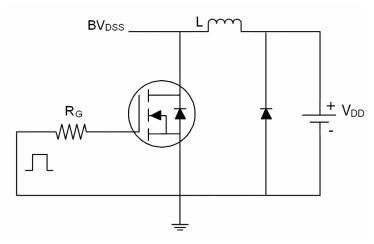
### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production

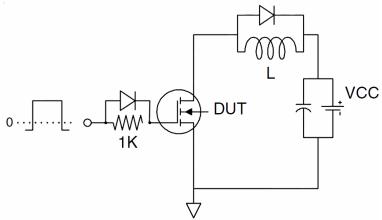


## **Test Circuit**

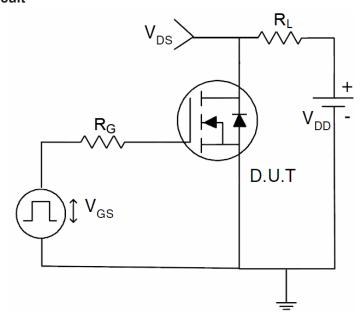
## 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit

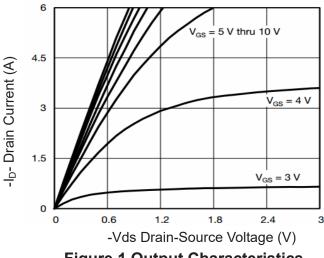


# 3) Switch Time Test Circuit

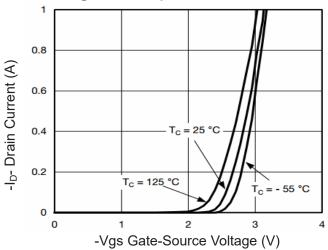




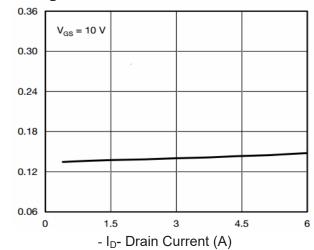
## Typical Electrical and Thermal Characteristics (Curves)



**Figure 1 Output Characteristics** 

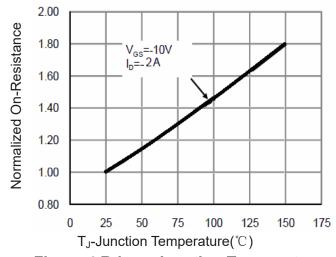


**Figure 2 Transfer Characteristics** 

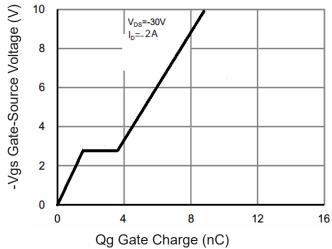


Rdson On-Resistance(  $\Omega$  )

Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 



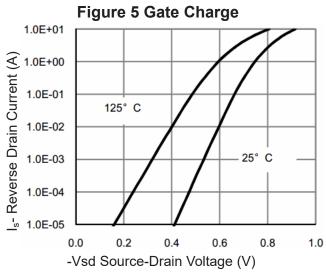


Figure 6 Source- Drain Diode Forward



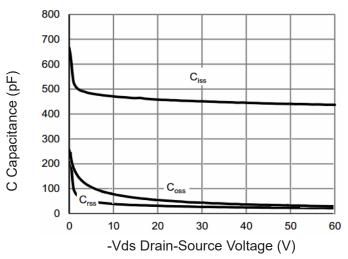
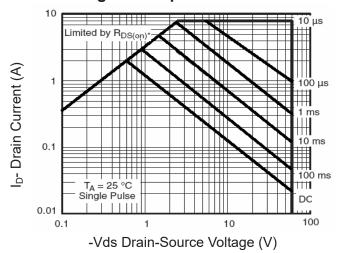
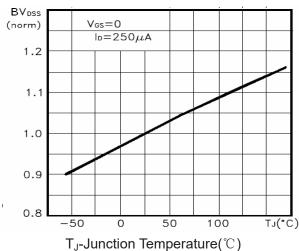


Figure 7 Capacitance vs Vds



**Figure 8 Safe Operation Area** 



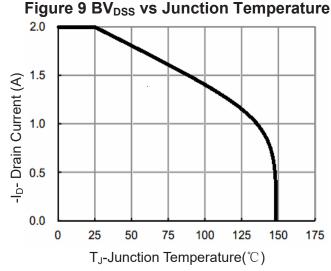


Figure 10 ID Current De-rating

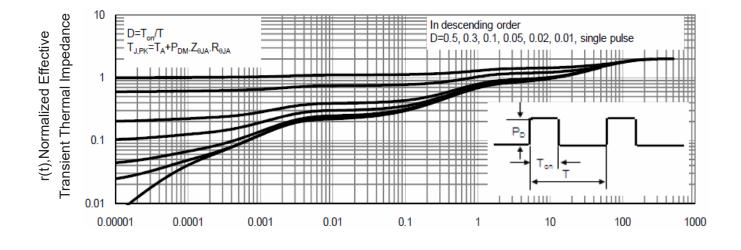


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)